

CGY2108GS Rev. V1

#### **Features**

Noise Figure:

0.60 @ 0.9 GHz 0.65 @ 1.9 GHz

0.50 @ 1.9 GHz (Dual Mode)

0.80 @ 3.2 GHz (SE Configuration)

· Gain:

23.0 @ 0.9 GHz 20.0 @ 1.9 GHz

21.5 @ 1.9 GHz (Dual Mode)

17.5 @ 3.2 GHz (SE Configuration)

OIP3:

36.5 @ 0.9 GHz

32.5 @ 1.9 GHz (Dual Mode)

29.0 @ 3.2 GHz (SE Configuration)

P1dB:

22.0 @ 1.9 GHz (Dual Mode)

Highly Reliable pHEMT MMIC Process

• 100% RF Tested

• Samples & Demonstration Boards Available

Space & MIL-STD Available

Hermetic Ceramic Package

RoHS\* Compliant

### **Applications**

Space Models

 Base Station (LTE, GSM, CDMA, WCDMA, TD-SCDMA, CDMA2000, WiMAX, etc.)

• Tower Mounted Amplifiers

Repeaters

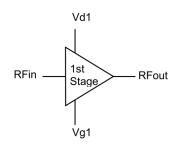
#### Description

The CGY2108GS is using the CGY2108UH die which is an extremely low noise cascade amplifier with state of the art noise figure and linearity suitable for applications from 0.5 to 6.0 GHz. The minimum noise figure of the CGY2108UH itself is below 0.32 dB at 1.9 GHz.

This device consists of a single amplifier chain and is ideal for use in a balanced configuration as well as a single ended amplifier.

The MMIC is manufactured using a qualified 0.25 µm pHEMT GaAs MMIC technology.

The device is available in a ceramic space grade hermetic package STRATEDGE G1616M-7F.





### **Pin Configuration**

Pin #	Function
1	RF Input
2,3,9,11	Ground
4 - 8,12	Not Connected
10	RF Output

#### **Ordering Information**

Part Number	Package
CGY2108GS	package
CGY2108UH	Die

<sup>\*</sup> Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



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# Electrical Specifications: Freq. = 0.5 - 6.0 GHz, $T_A = +23$ °C

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Gain	@ Package Lead, 1.90 GHz @ Reference Board <sup>1,3</sup> , 1.95 GHz @ Demonstration Board <sup>2,3</sup> , 1.90 GHz	dB	_	22.0 22.0 20.3	_
Noise Figure	@ Package Lead, 1.90 GHz @ Reference Board <sup>1,3</sup> , 1.95 GHz @ Demonstration Board <sup>2,3</sup> , 1.90 GHz	dB	0.32 — —	0.50 0.65	_
Bias Voltage	@ Package Lead, 1.90 GHz @ Reference Board <sup>1,3</sup> , 1.95 GHz @ Demonstration Board <sup>2,3</sup> , 1.90 GHz	dB	_	4 5 5	_
Bias Current	@ Package Lead, 1.90 GHz, $V_{EE} = -0.55 \text{ V}$ @ Reference Board <sup>1,3</sup> , 1.95 GHz $V_{EE1} = V_{EE2} = -0.55 \text{ V}$ @ Demonstration Board <sup>2,3</sup> , 1.90 GHz $V_{EE1} = V_{EE2} = -0.66 \text{ V}$	dB	_	50 50 50	_
Isolation	@ Reference Board <sup>1,3</sup> , 1.95 GHz IN1/IN2	dB	_	30	_
Reverse Isolation	@ Reference Board <sup>1,3</sup> , 1.95 GHz OUT/IN	dB	_	32	_
IIP3	@ Reference Board <sup>1,2</sup> , 1.95 GHz, 70 mA @ Demonstration Board <sup>2,3</sup> , 1.90 GHz	dBm	3.5 —	8.3 TBD	_
P1dB	@ Demonstration Board <sup>2,3</sup> , 1.90 GHz	dBm	_	10	_
Input Return Loss	@ Reference Board <sup>1,3</sup> , 1.95 GHz @ Demonstration Board <sup>2,3</sup> , 1.90 GHz 50 Ω Source	dB	_	-10 -22	_
Output Return Loss	@ Reference Board <sup>1,3</sup> , 1.95 GHz @ Demonstration Board <sup>2,3</sup> , 1.90 GHz 50 Ω Load	dB	_	-10 -22	_

- 1. Single ended configuration with on-board bias resistors.
- Balanced configuration with on-board bias resistors.
- 3. Measured reference plane are the input and output SMA connectors.

# **Absolute Maximum Ratings**<sup>4,5</sup>

Parameter	Absolute Maximum
Input Power	10 dBm
Gate Voltage	-3 to +1 V
Drain Voltage	-3 to +10 V
Drain Current	70 mA
Junction Temperature	+150°C
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +150°C

<sup>4.</sup> Exceeding any one or combination of these limits may cause permanent damage to this device.

#### **Thermal Characteristics**

Parameter	Absolute Maximum
Thermal Resistance	70°C/W

### **Handling Procedures**

Please observe the following precautions to avoid damage:

#### **Static Sensitivity**

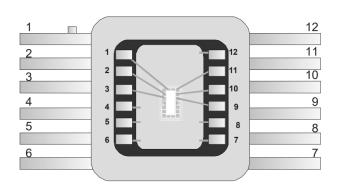
These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

MACOM does not recommend sustained operation near these survivability limits.

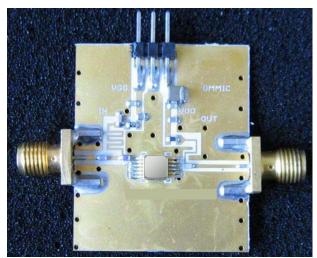


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# **Internal Bonding Diagram**



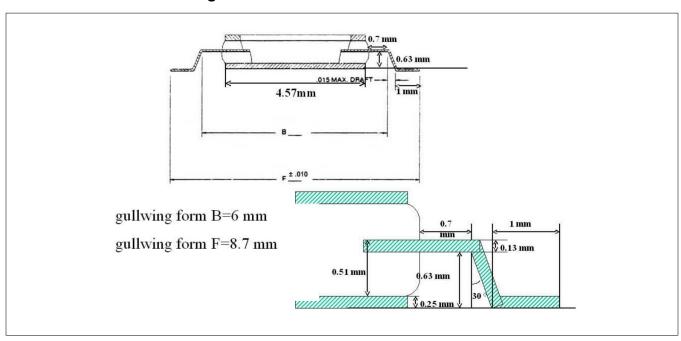
### Reference Circuit Board, 1.9 GHz



#### **Parts List**

Part	Value	Case Style
TBD		

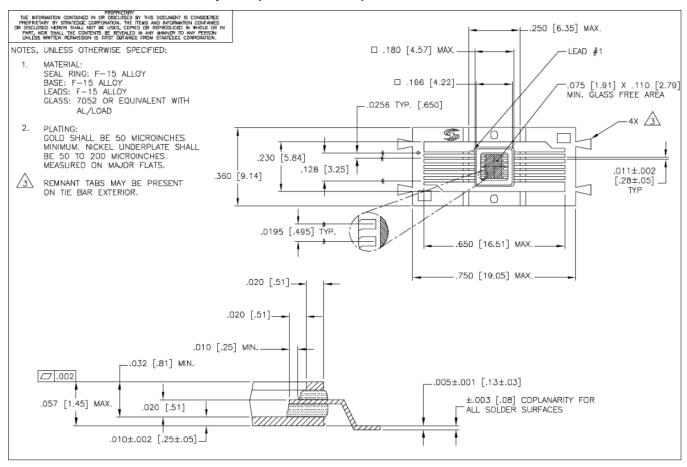
# **Dimensions of the Gullwing Leads**





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#### Outline: 12-Lead Glass Flatpack (formed leads) & PCB Land Pattern





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